



Solid State Devices, Inc.

14830 Valley View Blvd * La Mirada, Ca 90638

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DESIGNER'S DATA SHEET

Part Number / Ordering Information ^{1/}

SFF450

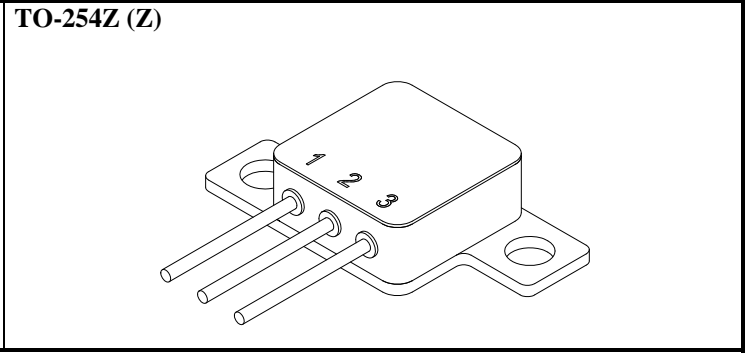
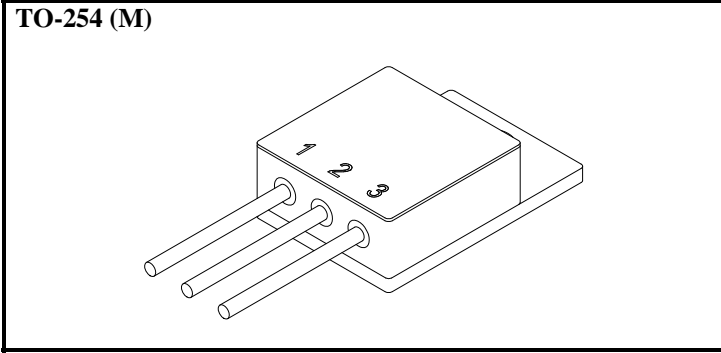
- Screening ^{2/} ___ = Not Screen
 - TX = TX Level
 - TXV = TXV Level
 - S = S Level
- Lead Option ^{3/} ___ = Straight Leads
 - DB = Down Bend
 - UB = Up Bend
- Package ^{3/} M = TO-254
Z = TO-254Z

SFF450M
SFF450Z

13 AMP / 500 Volts
0.4 Ω
N-Channel POWER MOSFET

- Features:**
- Rugged Construction with Polysilicon Gate Cell
 - Low $R_{DS(ON)}$ and High Transconductance
 - Excellent High Temperature Stability
 - Very Fast Switching Speed
 - Fast Recovery and Superior dV/dt Performance
 - Increased Reverse Energy Capability
 - Low Input and Transfer Capacitance for Easy Paralleling
 - Ceramic Seals Available for Improved Hermeticity
 - Hermetically Sealed Surface Mount Power Package
 - TX, TXV, Space Level Screening Available
 - Replacement for IRFM450 Types

Maximum Ratings		Symbol	Value	Units
Drain – Source Voltage		V_{DS}	500	Volts
Gate – Source Voltage		V_{GS}	±20	Volts
Continuous Collector Current		I_D	13	Amps
Operating & Storage Temperature		Top & Tstg	-55 to +150	°C
Maximum Thermal Resistance Junction to Case		$R_{θJC}$	1	°C/W
Total Device Dissipation	$T_C = 25°C$ $T_C = 55°C$	P_D	125 95	W



For Pin Out Configuration and Optional Lead Bend, Se Page 3.

NOTE: All specifications are subject to change without notification. SCD's for these devices should be reviewed by SSDI prior to release.

DATA SHEET #: F00097E

DOC

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SFF450M**SFF450Z**

Electrical Characteristics @ T_J = 25°C (Unless Otherwise Specified)		Symbol	Min	Typ	Max	Units
Drain to Source Breakdown Voltage (VGS=0 V, ID=250 μA)		BV_{DSS}	500	—	—	Volts
Drain to Source On State Resistance (VGS=10 V, ID= 7.2 A)		R_{DS(on)}	—	0.35	0.40	Ω
On State Drain Current (VDS>ID(on) X RDS(on) Max, VGS=10 V)		I_{D(on)}	13	—	—	A
Gate Threshold Voltage (VDS=VGS, ID= 250 μA)		V_{GS(th)}	2.0	—	4.0	V
Forward Transconductance (VDS≥ 50 V, IDS= 7.2 A)		g_{fs}	8.7	131	—	mho
Zero Gate Voltage Drain Current (VDS=max rated voltage, VGS=0 V) (VDS=80% rated VDS, VGS=0 V, TA=125°C)		I_{DSS}	—	—	250 1000	μA
Gate to Source Leakage Forward Gate to Source Leakage Reverse	At rated VGS	I_{GSS}	—	—	+100 -100	nA
Total Gate Charge Gate to Source Charge Gate to Drain Charge	VGS=10 Volts 80% rated VDS Rated ID	Q_g Q_{gs} Q_{gd}	—	83 11 42	120 17 64	nC
Turn on Delay Time Rise Time Turn on Delay Time Fall Time	VDD=50% Rated VDS 50% Rated ID RG= 6.2Ω PD= 20 W	td_(on) tr td_(off) tf	—	18 44 70 40	27 66 100 60	nsec
Diode Forward Voltage (IS= Rated ID, VGS=0 V, T _J =25°C)		V_{SD}	—	—	1.4	V
Diode Reverse Recovery Time Reverse Recovery Charge	T _J =25°C IF= Rated ID di/dt=100A/μsec	t_{rr} Q_{RR}	280 3.2	580 6.7	1200 14	nsec μC
Input Capacitance Input Capacitance Reverse Transfer Capacitance	VGS=0 Volts VDS=25 Volts f=1 MHz	C_{iss} C_{oss} C_{rss}	—	2700 350 75	—	pF

For thermal derating curves and other characteristics please contact SSDI Marketing Department.

Available Part Numbers:

SFF450M; SFF450MDB; SFF450MUB;
SFF450Z; SFF450ZDB; SFF450ZUB;

PIN ASSIGNMENT (Standard)

Package	Drain	Source	Gate
TO-254 (M)	Pin 1	Pin 2	Pin 3
TO-254Z (Z)	Pin 1	Pin 2	Pin 3

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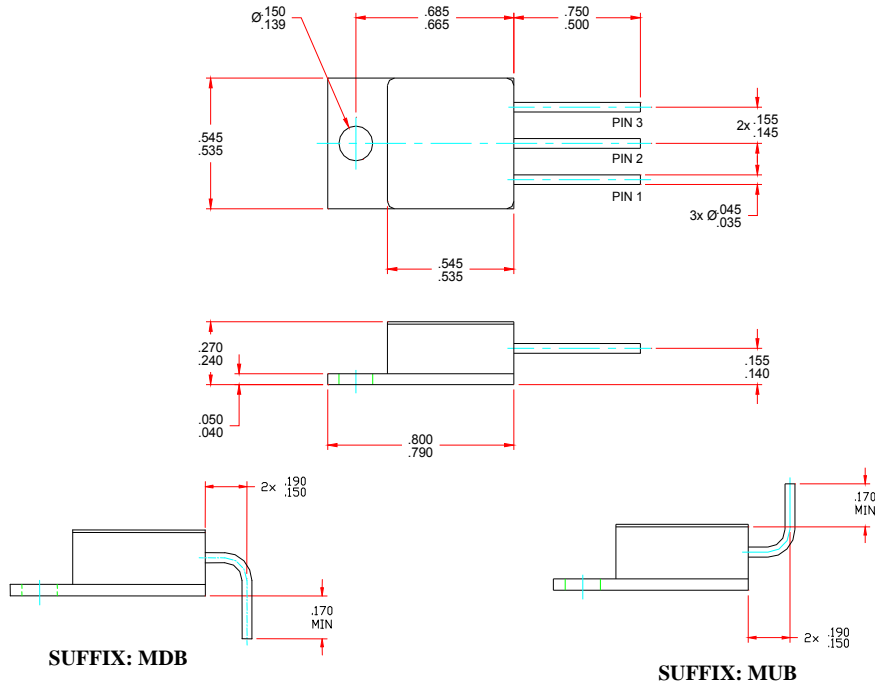
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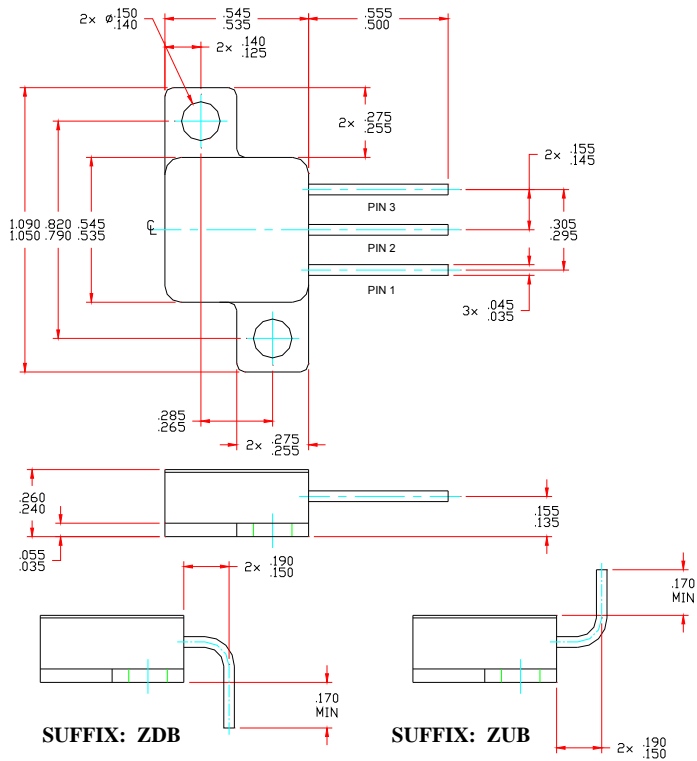
SFF450M

SFF450Z

Case Outline: TO-254 (M)



Case Outline: TO-254Z (Z)



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